Amortizing Embodied Carbon Across Generations

The 15th International Green and Sustainable Computing Conference (IGSC '24) Shixin Ji*, Jinming Zhuang*, Zhuoping Yang*, Alex K. Jones†, and Peipei Zhou*

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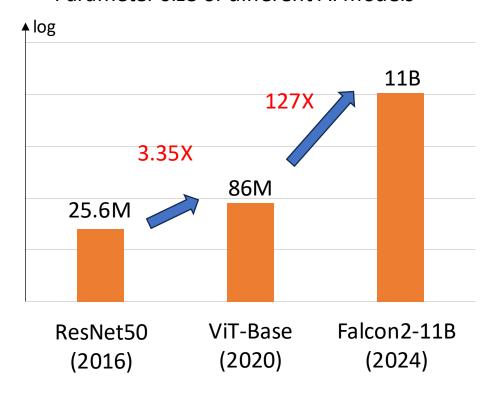
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https://peipeizhou-eecs.github.io/



Challenges of Extending Device Lifetime

Parameter size of different AI models



AMD U250 vs. AMD VCK5000

AMD VCK5000

FPGA+AI Engine(tensor core-like)

145 TOPS (INT8)

644.4GOP/J

Applications are evolving: Old devices may not handle

Accelerator are evolving: New devices have better energy efficiencies

20.9X

2024/11/5

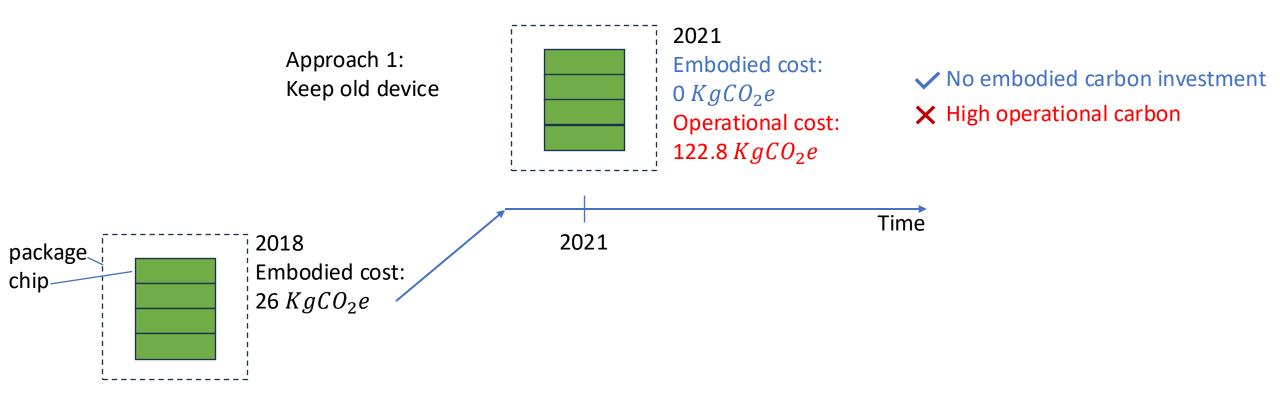
AMD U250 (2018)

FPGA

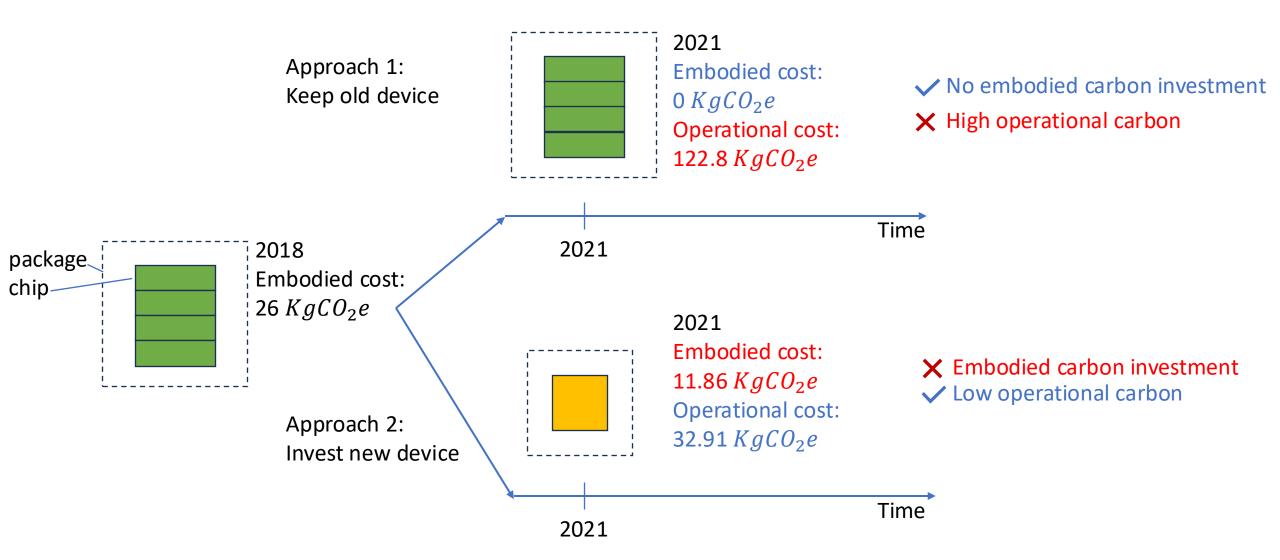
6.95 TOPS(INT8)

30.9GOP/J

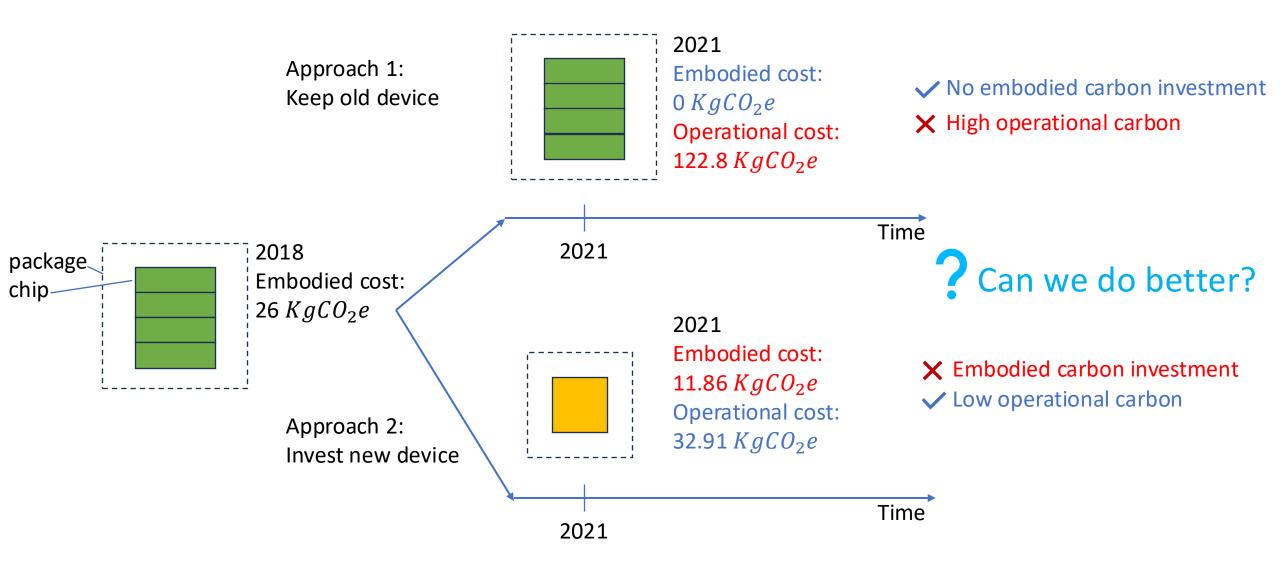
Baseline Approaches



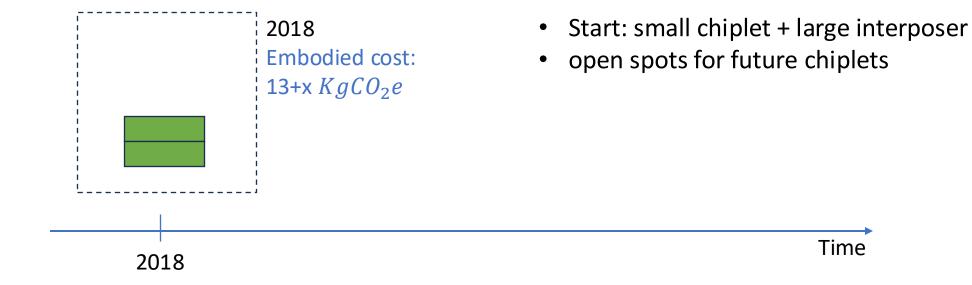
Baseline Approaches



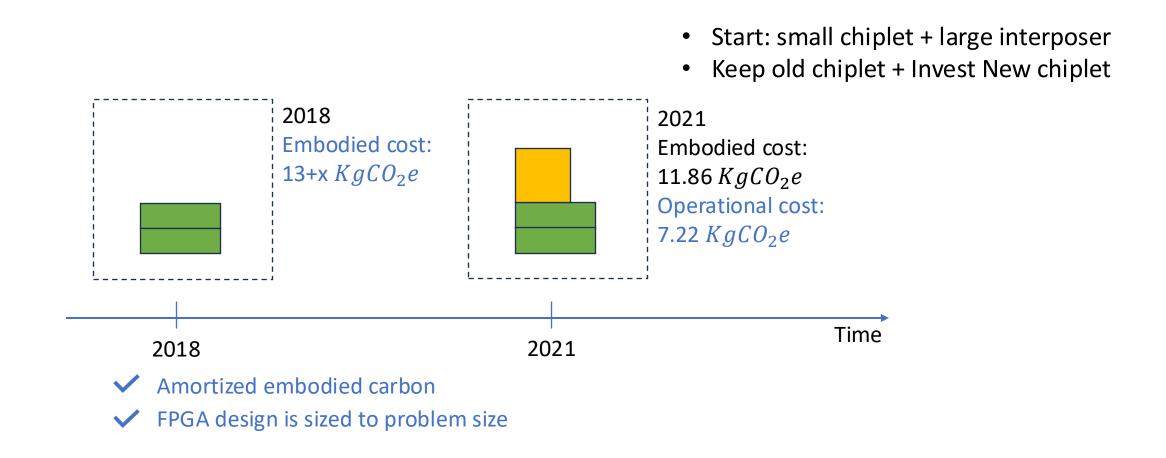
Baseline Approaches

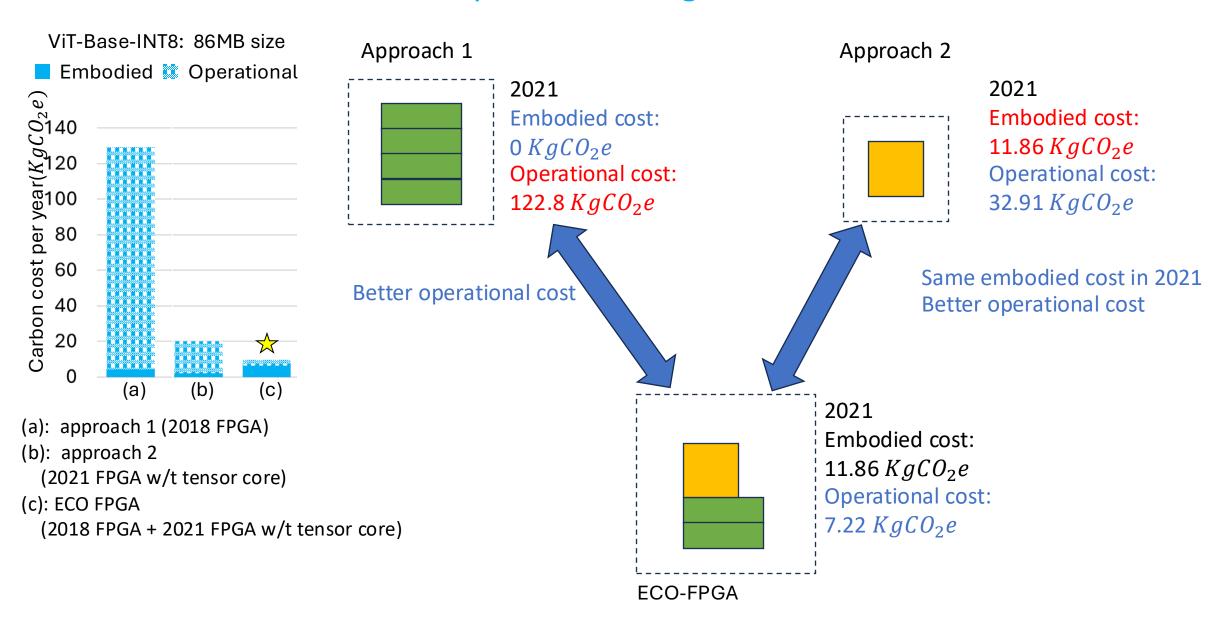


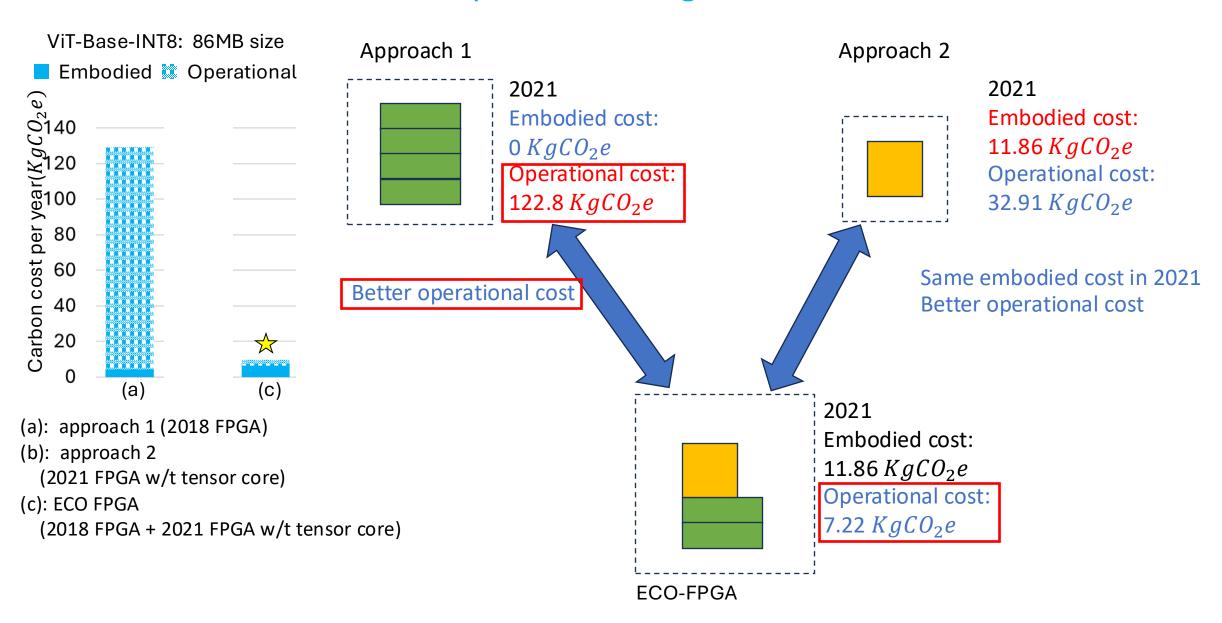
Embodied carbon optimized (ECO) FPGA systems

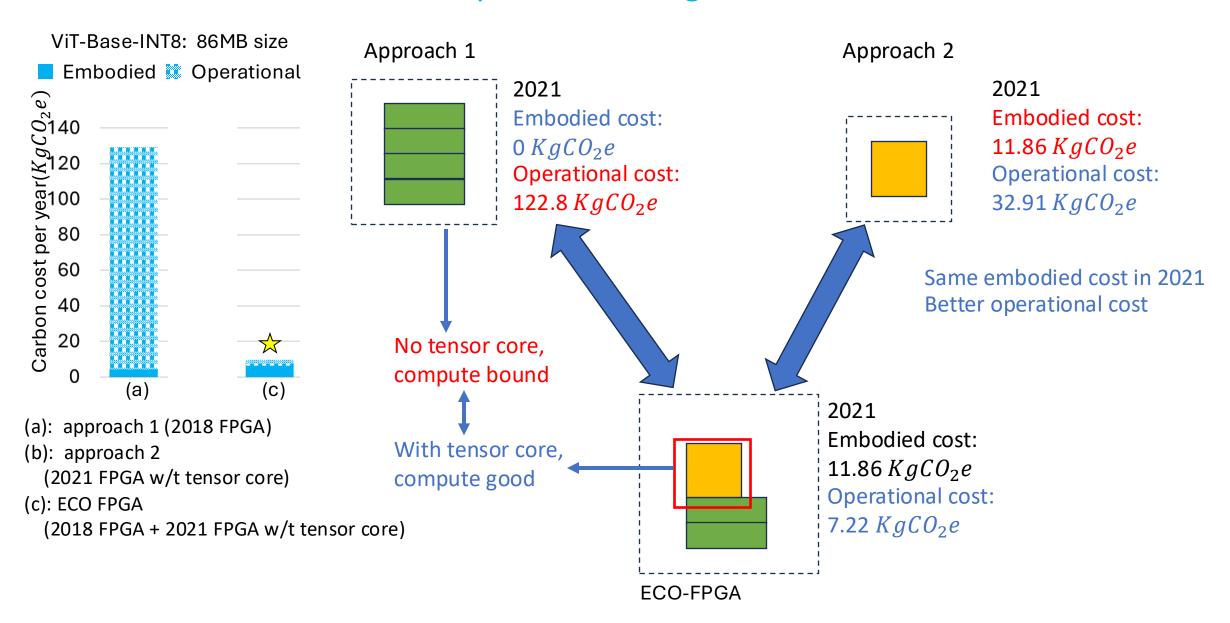


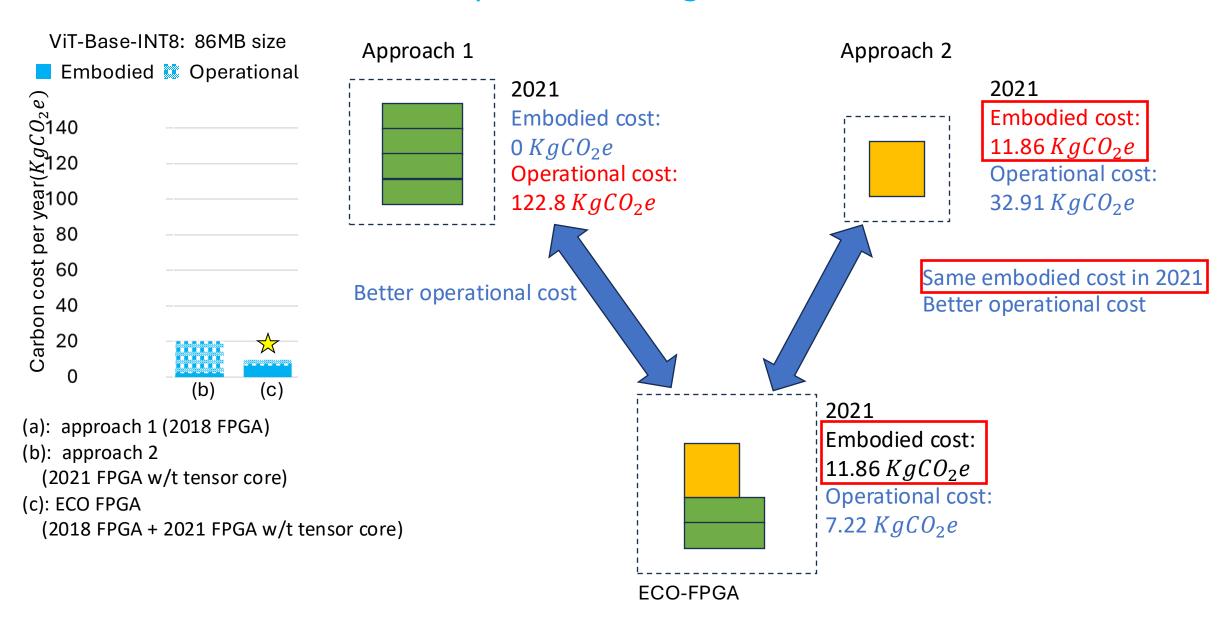
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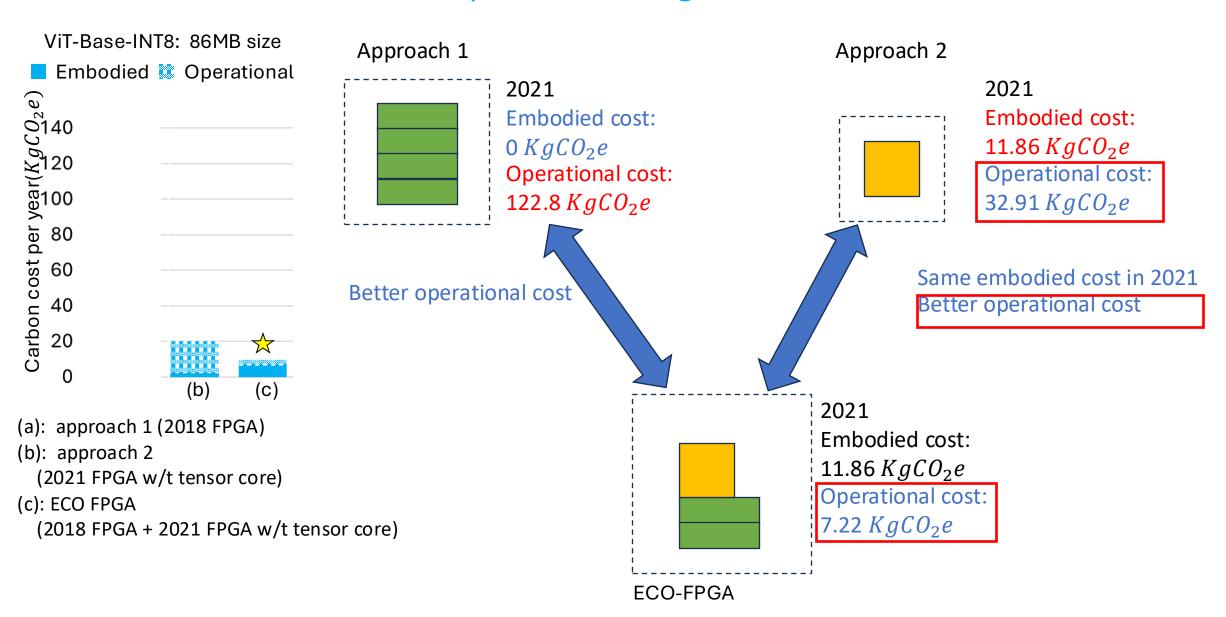


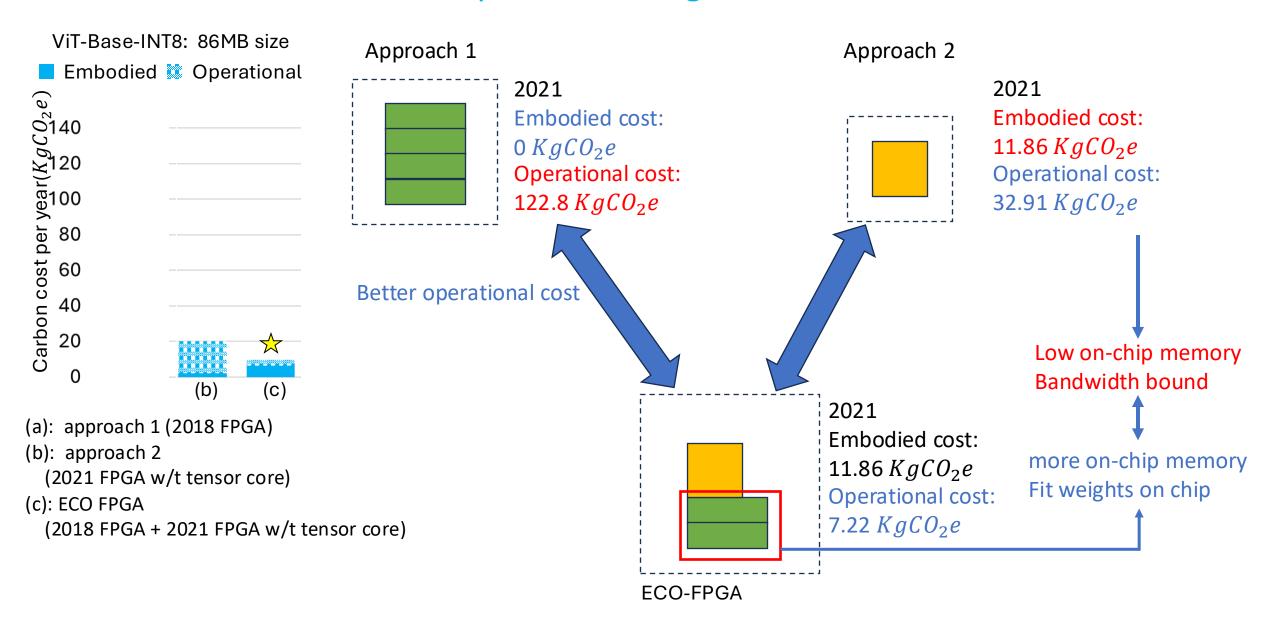










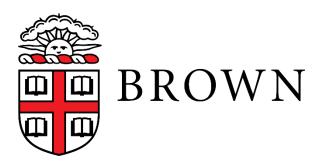


Thank You

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